

V_{DSS}	150V
$R_{DS(on)}$ (Typ.)	40m Ω
Q_G , typ.	2nC
$I_{D(Tc=25^\circ C)}$ ^{*2}	10A
$Q_{OSS@50V}$	13nC
Q_{rr}	0nC

●Features

- 150V E-mode GaN FET
- High Gate Voltage Maximum Rating
- Reliable and easy to use with DFN package

●Application

- Half Bridge topologies
- AC/DC Converters (secondary side)
- Class D Audio amplifiers
- IR LED, LD driver

●Absolute maximum ratings ($T_a = 25^\circ C$)

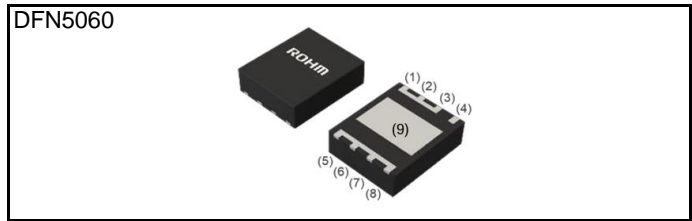
Parameter	Symbol	Value	Unit	
Continuous Drain current	$T_a = 25^\circ C$	I_D ^{*1}	6.6	A
	$T_c = 25^\circ C$	I_D ^{*2}	10.0	A
Pulse Drain current	$T_a = 25^\circ C$	$I_{D,pulse}$ ^{*3}	26.4	A
Drain - Source Voltage	V_{DSS}	150	V	
Gate - Source voltage (DC)	V_{GSS}	-2 to +8	V	
Recommended drive voltage	V_{GS_op}	0 / +5	V	
Junction temperature	T_j	150	$^\circ C$	

*1 Limited by maximum temperature allowed.

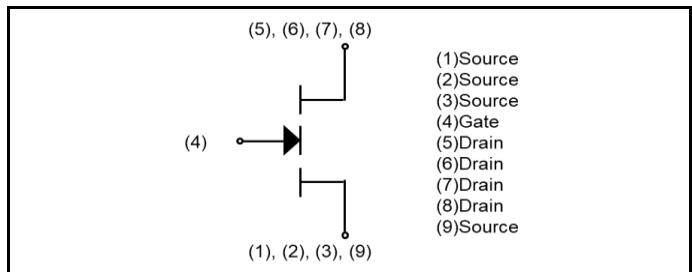
*2 Limited by electro migration lifetime allowed.

*3 $V_{GS}=5V$, $t_{pulse}=100\mu s$.

●Outline



●Inner circuit



●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 100\mu A$ $T_j = 25^\circ\text{C}$	150	-	-	V
Zero Gate voltage Drain current	I_{DSS}	$V_{GS} = 0V, V_{DS}=150V$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	10 500	100 -	μA
Gate - Source leakage current	I_{GSS+}	$V_{GS} = 8V, V_{DS} = 0V$	-	0.2	200	μA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 1mA$	0.8	1	2.5	V
Static Drain - Source on - state resistance	$R_{DS(on)}^{*4}$	$V_{GS} = 5V, I_D = 2.0A$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	- -	40 80	60 -	$m\Omega$
Gate input resistance	R_G	$f = 10MHz, \text{open drain}$	-	1	-	Ω

●Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - ambient	R_{thJA}	-	48	-	$^\circ\text{C/W}$
Thermal resistance, junction - case	R_{thJC}	-	1.8	-	$^\circ\text{C/W}$

*4 Pulsed

●Electrical characteristics ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input capacitance	C_{iss}	$V_{GS} = 0V$	-	260	-	pF
Output capacitance	C_{oss}	$V_{DS} = 120V$	-	110	-	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$	-	1.2	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 50V$	-	141	-	pF
Effective output capacitance, time related	$C_{o(tr)}$	$V_{GS} = 0V$ $V_{DS} = 0V \text{ to } 50V$	-	260	-	pF
Output charge	Q_{oss}^{*4}	$V_{DS} = 50V$ $V_{GS} = 0V$	-	13	-	nC
Total Gate charge	Q_g^{*4}	$V_{DS} = 50V$ $I_D = 5A$	-	2.0	-	nC
Gate - Source charge	Q_{gs}^{*4}	$V_{GS} = 5V/0V$	-	0.4	-	
Gate - Drain charge	Q_{gd}^{*4}		-	0.5	-	
Gate plateau voltage	V_{plat}		-	2.0	-	

●Reverse conduction electrical characteristics ($T_a = 25^\circ\text{C}$)

Source-Drain reverse voltage	V_{SD}	$V_{GS} = 0V, I_{SD}=1.9A$	-	2.0	-	V
Reverse recovery time	t_{rr}^{*4}		-	0	-	ns
Reverse recovery charge	Q_{rr}^{*4}		-	0	-	nC
Peak reverse recovery current	I_{mm}^{*4}		-	0	-	A

*4 Pulsed

●Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

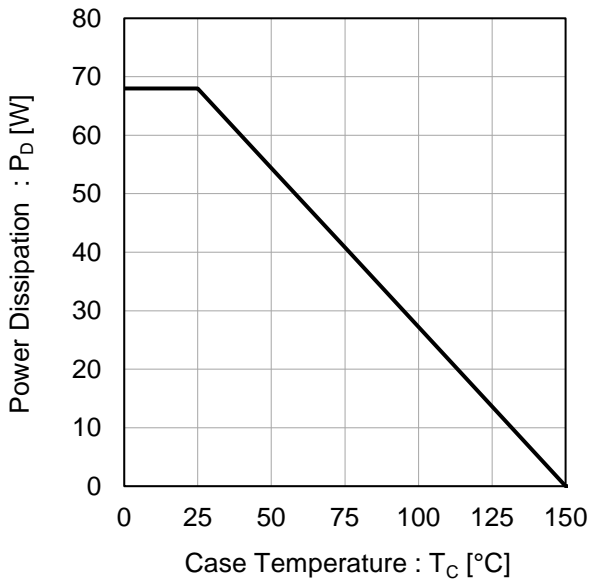


Fig.2 Normalized Transient Thermal Resistance vs. Pulse Width

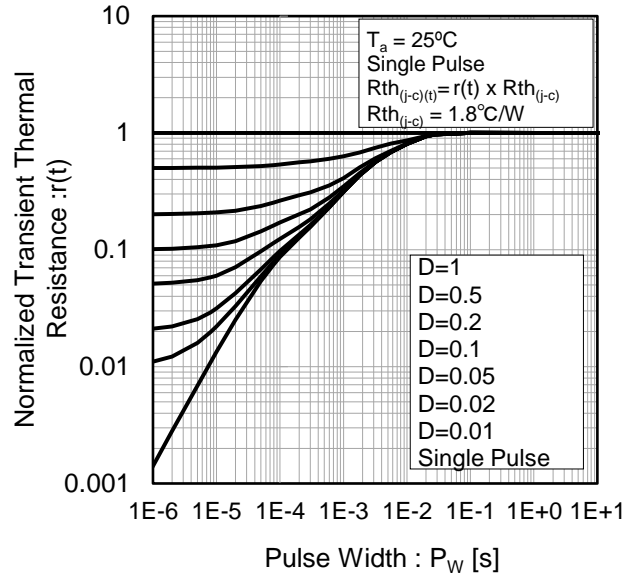
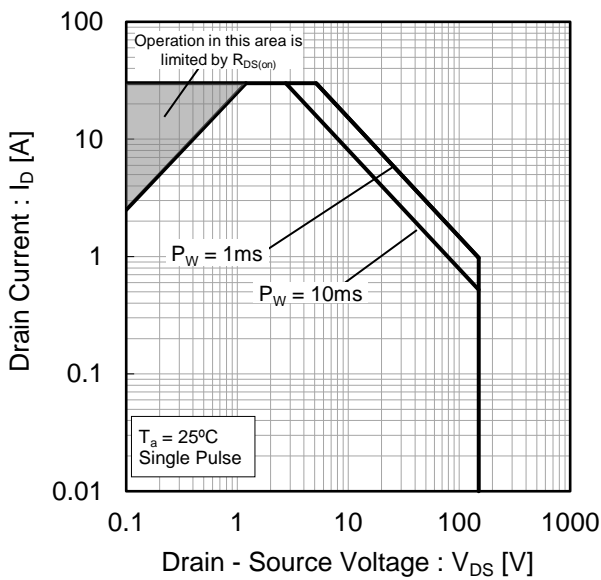


Fig.3 Maximum Safe Operating Area ($T_a=25^\circ\text{C}$)



●Electrical characteristic curves

Fig.4 $T_a = 25^\circ\text{C}$ Typical Output Characteristics

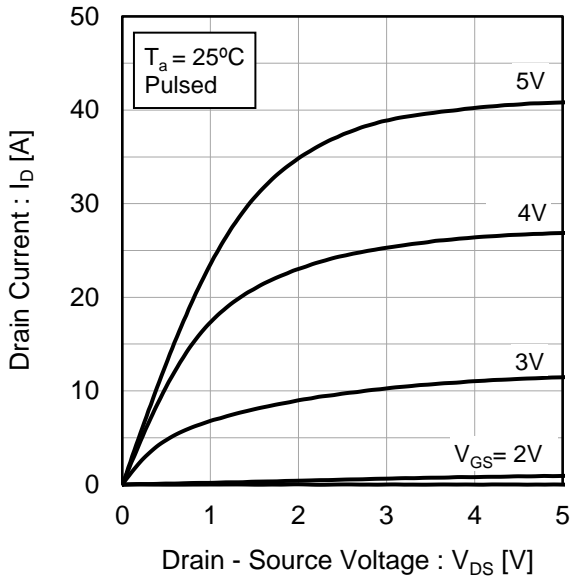


Fig.5 $T_a = 150^\circ\text{C}$ Typical Output Characteristics

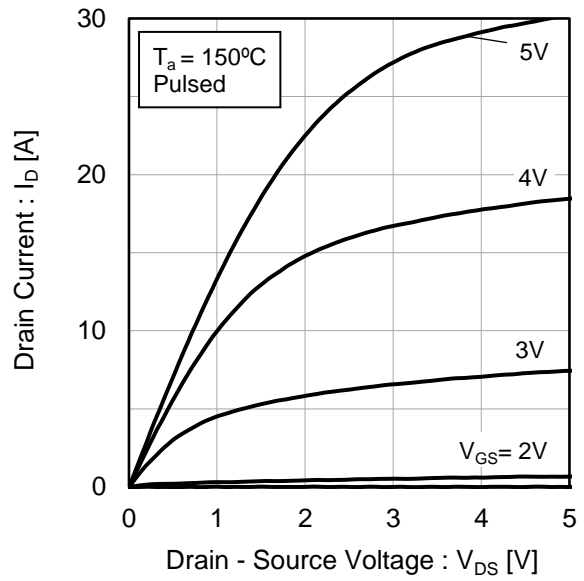


Fig.6 Typical Transfer Characteristics

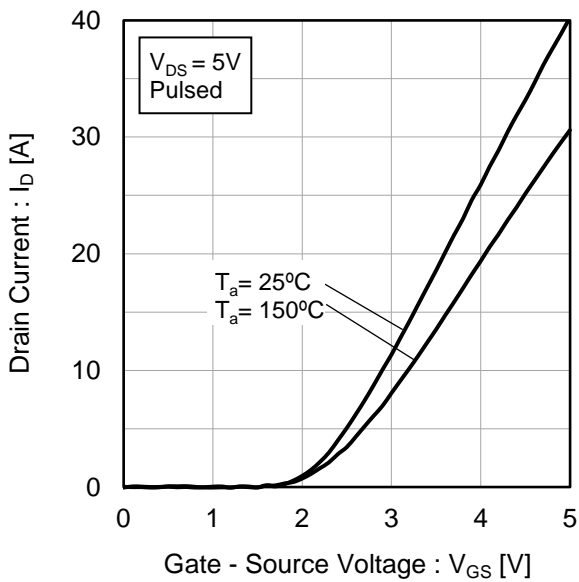
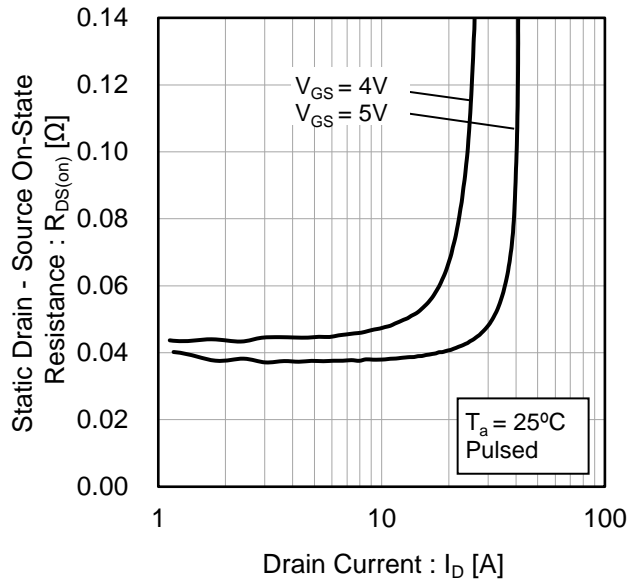


Fig.7 Static Drain - Source On - State Resistance vs. Drain - Source Current



●Electrical characteristic curves

Fig.8 3rd Quadrant Characteristics

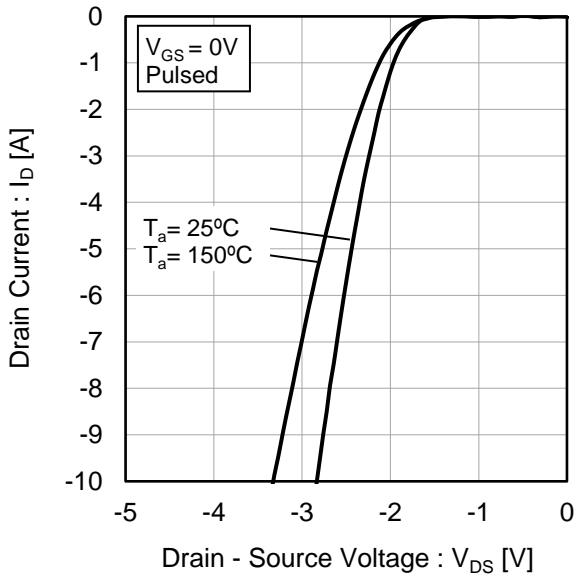


Fig.9 Typical Capacitance vs. Drain - Source Voltage

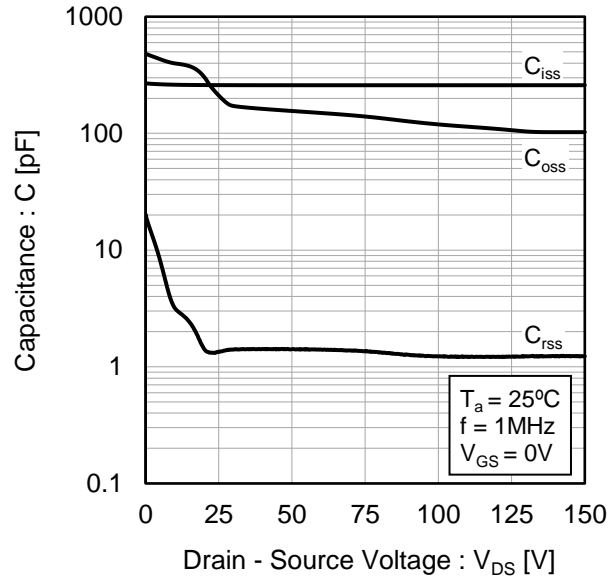
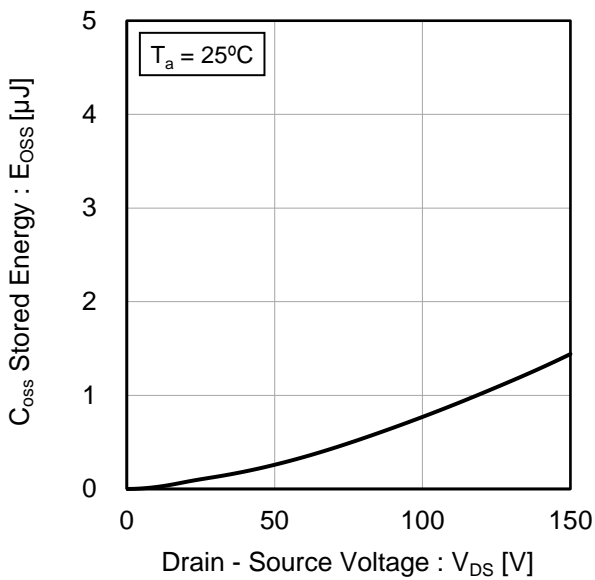
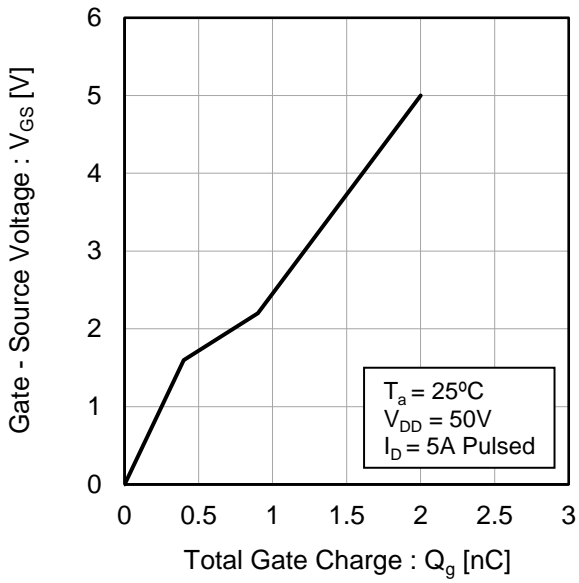


Fig.10 C_{oss} Stored Energy

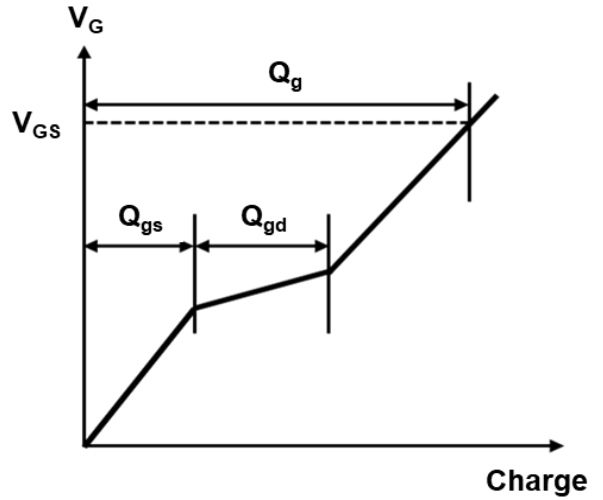


●Electrical characteristic curves

Fig.13 Dynamic Input Characteristics

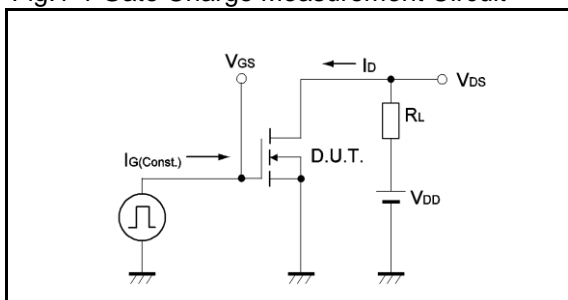


*Gate Charge Waveform



● Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit



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JAPAN	USA	EU	CHINA
CLASS III	CLASS III	CLASS II b	CLASS III
CLASS IV		CLASS III	

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 - Use of the Products in places subject to dew condensation
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- De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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